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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Coyle et al.

Docket Number: TI-31794

Serial No.: 09/992,387

Art Unit: 2822

Filed: 11/16/2001

Examiner: Monica Lewis

For: FLIP-CHIP ON FILM ASSEMBLY FOR BALL GRID ARRAY PACKAGES

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NAME OF INVENTOR(S): Coyle et al.	
RECEIPT DATE & SERIAL NO.: Serial No.: 09/992,387	
TITLE OF INVENTION: Flip-Chip on Film Assembly for Ball Grid...	
TI FILE NO.: TI-31794	DEPOSIT ACCT. NO.: 20-0668
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Texas Instruments Incorporated
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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION**

Appl. No. : 09/992,387 Confirmation No. 7595
Applicant : Anthony L. Coyle et al.
Filed : November 16, 2001
TC/A.U. : 2822
Examiner : Lewis, Monica
Docket No. : TI-31794
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AMENDMENT-A UNDER 37 CFR 1.111

Dear Sir:

Responsive to the Office action dated August 25, 2004, applicants amend the application as follows:

Listing of the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 3 of this paper.